

# Octal D-Type Flip-Flop with 3-State Output

The MC74VHCT574A is an advanced high speed CMOS octal flip-flop with 3-state output fabricated with silicon gate CMOS technology. It achieves high speed operation similar to equivalent Bipolar Schottky TTL while maintaining CMOS low power dissipation.

This 8-bit D-type flip-flop is controlled by a clock input and an output enable input. When the output enable input is high, the eight outputs are in a high impedance state.

The VHCT inputs are compatible with TTL levels. This device can be used as a level converter for interfacing 3.3V to 5.0V, because it has full 5V CMOS level output swings.

The VHCT574A input and output (when disabled) structures provide protection when voltages between 0V and 5.5V are applied, regardless of the supply voltage. These input and output structures help prevent device destruction caused by supply voltage – input/output voltage mismatch, battery backup, hot insertion, etc.

- High Speed:  $f_{max} = 140\text{MHz}$  (Typ) at  $V_{CC} = 5\text{V}$
- Low Power Dissipation:  $I_{CC} = 4\mu\text{A}$  (Max) at  $T_A = 25^\circ\text{C}$
- TTL-Compatible Inputs:  $V_{IL} = 0.8\text{V}$ ;  $V_{IH} = 2.0\text{V}$
- Power Down Protection Provided on Inputs and Outputs
- Balanced Propagation Delays
- Designed for 4.5V to 5.5V Operating Range
- Low Noise:  $V_{OLP} = 1.6\text{V}$  (Max)
- Pin and Function Compatible with Other Standard Logic Families
- Latchup Performance Exceeds 300mA
- ESD Performance: HBM > 2000V; Machine Model > 200V
- Chip Complexity: 286 FETs or 71.5 Equivalent Gates

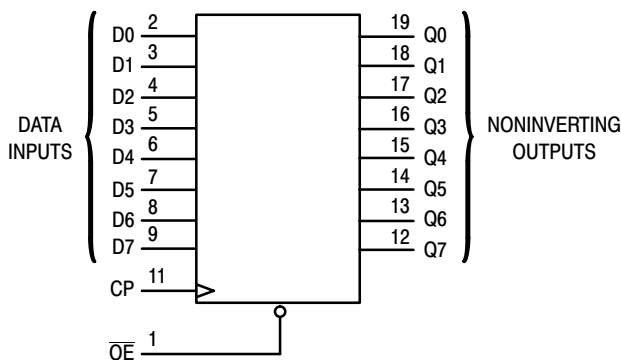
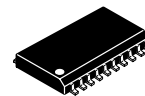


Figure 1. Logic Diagram

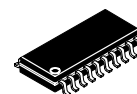
## MC74VHCT574A



**DW SUFFIX**  
20-LEAD SOIC WIDE PACKAGE  
CASE 751D-05



**DT SUFFIX**  
20-LEAD TSSOP PACKAGE  
CASE 948E-02



**M SUFFIX**  
20-LEAD SOIC EIAJ PACKAGE  
CASE 967-01

**ORDERING INFORMATION**

MC74VHCTXXXADW	SOIC WIDE
MC74VHCTXXXADT	TSSOP
MC74VHCTXXXAM	SOIC EIAJ

**FUNCTION TABLE**

INPUTS			OUTPUT
$\overline{OE}$	CP	D	Q
L		H	H
L		L	L
L	L, H,	X	No Change
H	X	X	Z

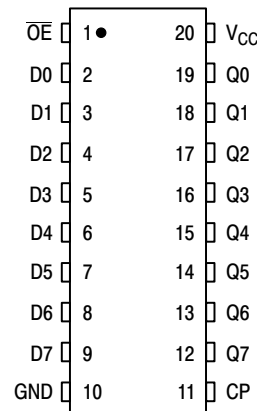


Figure 2. Pin Assignment

# MC74VHCT574A

## MAXIMUM RATINGS\*

Symbol	Parameter	Value	Unit
$V_{CC}$	DC Supply Voltage	- 0.5 to + 7.0	V
$V_{in}$	DC Input Voltage	- 0.5 to + 7.0	V
$V_{out}$	DC Output Voltage Outputs in 3-State High or Low State	- 0.5 to + 7.0 - 0.5 to $V_{CC} + 0.5$	V
$I_{IK}$	Input Diode Current	- 20	mA
$I_{OK}$	Output Diode Current ( $V_{OUT} < GND$ ; $V_{OUT} > V_{CC}$ )	$\pm 20$	mA
$I_{out}$	DC Output Current, per Pin	$\pm 25$	mA
$I_{CC}$	DC Supply Current, $V_{CC}$ and GND Pins	$\pm 75$	mA
$P_D$	Power Dissipation in Still Air, SOIC Packages† TSSOP Package†	500 450	mW
$T_{stg}$	Storage Temperature	- 65 to + 150	°C

This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation,  $V_{in}$  and  $V_{out}$  should be constrained to the range  $GND \leq (V_{in} \text{ or } V_{out}) \leq V_{CC}$ . Unused inputs must always be tied to an appropriate logic voltage level (e.g., either GND or  $V_{CC}$ ). Unused outputs must be left open.

\* Absolute maximum continuous ratings are those values beyond which damage to the device may occur. Exposure to these conditions or conditions beyond those indicated may adversely affect device reliability. Functional operation under absolute-maximum-rated conditions is not implied.

† Derating — SOIC Packages: - 7 mW/°C from 65° to 125°C  
TSSOP Package: - 6.1 mW/°C from 65° to 125°C

## RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min	Max	Unit
$V_{CC}$	DC Supply Voltage	4.5	5.5	V
$V_{in}$	DC Input Voltage	0	5.5	V
$V_{out}$	DC Output Voltage Outputs in 3-State High or Low State	0 0	5.5 $V_{CC}$	V
$T_A$	Operating Temperature	- 40	+ 85	°C
$t_r, t_f$	Input Rise and Fall Time $V_{CC} = 5.0V \pm 0.5V$	0	20	ns/V

## DC ELECTRICAL CHARACTERISTICS

Symbol	Parameter	Test Conditions	$V_{CC}$ V	$T_A = 25^\circ\text{C}$			$T_A = -40 \text{ to } 85^\circ\text{C}$		Unit
				Min	Typ	Max	Min	Max	
$V_{IH}$	Minimum High-Level Input Voltage		4.5 to 5.5	2.0			2.0		V
$V_{IL}$	Maximum Low-Level Input Voltage		4.5 to 5.5			0.8		0.8	V
$V_{OH}$	Minimum High-Level Output Voltage $V_{in} = V_{IH}$ or $V_{IL}$	$I_{OH} = -50\mu\text{A}$	4.5	4.4	4.5		4.4		V
		$I_{OH} = -8\text{mA}$	4.5	3.94		3.80			
$V_{OL}$	Maximum Low-Level Output Voltage $V_{in} = V_{IH}$ or $V_{IL}$	$I_{OL} = 50\mu\text{A}$	4.5		0.0	0.1		0.1	V
		$I_{OL} = 8\text{mA}$	4.5			0.36		0.44	
$I_{in}$	Maximum Input Leakage Current	$V_{in} = 5.5\text{V}$ or GND	0 to 5.5			$\pm 0.1$		$\pm 1.0$	$\mu\text{A}$
$I_{OZ}$	Maximum 3-State Leakage Current	$V_{in} = V_{IL}$ or $V_{IH}$ $V_{out} = V_{CC}$ or GND	5.5			$\pm 0.25$		$\pm 2.5$	$\mu\text{A}$
$I_{CC}$	Maximum Quiescent Supply Current	$V_{in} = V_{CC}$ or GND	5.5			4.0		40.0	$\mu\text{A}$

# MC74VHCT574A

## DC ELECTRICAL CHARACTERISTICS

Symbol	Parameter	Test Conditions	V <sub>CC</sub> V	T <sub>A</sub> = 25°C			T <sub>A</sub> = - 40 to 85°C		Unit
				Min	Typ	Max	Min	Max	
I <sub>CC</sub> T	Quiescent Supply Current	Per Input: V <sub>IN</sub> = 3.4V Other Input: V <sub>CC</sub> or GND	5.5			1.35		1.50	mA
I <sub>OPD</sub>	Output Leakage Current	V <sub>OUT</sub> = 5.5V	0			0.5		5.0	μA

## AC ELECTRICAL CHARACTERISTICS (Input t<sub>r</sub> = t<sub>f</sub> = 3.0ns)

Symbol	Parameter	Test Conditions	T <sub>A</sub> = 25°C			T <sub>A</sub> = - 40 to 85°C		Unit
			Min	Typ	Max	Min	Max	
f <sub>max</sub>	Maximum Clock Frequency (50% Duty Cycle)	V <sub>CC</sub> = 5.0 ± 0.5V C <sub>L</sub> = 15pF C <sub>L</sub> = 50pF	90 85	140 130		80 95		MHz
t <sub>PLH</sub> , t <sub>PHL</sub>	Maximum Propagation Delay, CP to Q	V <sub>CC</sub> = 5.0 ± 0.5V C <sub>L</sub> = 15pF C <sub>L</sub> = 50pF		4.1 5.6	9.4 10.4	1.0 1.0	10.5 11.5	ns
t <sub>PZL</sub> , t <sub>PZH</sub>	Output Enable Time, OE to Q	V <sub>CC</sub> = 5.0 ± 0.5V R <sub>L</sub> = 1kΩ C <sub>L</sub> = 50pF		6.5 7.3	10.2 11.2	1.0 1.0	11.5 12.5	ns
t <sub>PLZ</sub> , t <sub>PHZ</sub>	Output Disable Time, OE to Q	V <sub>CC</sub> = 5.0 ± 0.5V R <sub>L</sub> = 1kΩ C <sub>L</sub> = 50pF		7.0	11.2	1.0	12.0	ns
t <sub>OSLH</sub> , t <sub>OSHL</sub>	Output to Output Skew	V <sub>CC</sub> = 5.0 ± 0.5V C <sub>L</sub> = 50pF (Note 1.)			1.0		1.0	ns
C <sub>in</sub>	Maximum Input Capacitance			4	10		10	pF
C <sub>out</sub>	Maximum Three-State Output Capacitance, Output in High-Impedance State			9				pF

C <sub>PD</sub>	Power Dissipation Capacitance (Note 2.)	Typical @ 25°C, V <sub>CC</sub> = 5.0V		pF
		25		

- Parameter guaranteed by design. t<sub>OSLH</sub> = |t<sub>PLHm</sub> - t<sub>PLHn</sub>|, t<sub>OSHL</sub> = |t<sub>PHLm</sub> - t<sub>PHLn</sub>|.
- C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation: I<sub>CC(OPR)</sub> = C<sub>PD</sub> • V<sub>CC</sub> • f<sub>in</sub> + I<sub>CC</sub>/8 (per flip-flop). C<sub>PD</sub> is used to determine the no-load dynamic power consumption; P<sub>D</sub> = C<sub>PD</sub> • V<sub>CC</sub><sup>2</sup> • f<sub>in</sub> + I<sub>CC</sub> • V<sub>CC</sub>.

## NOISE CHARACTERISTICS (Input t<sub>r</sub> = t<sub>f</sub> = 3.0ns, C<sub>L</sub> = 50pF, V<sub>CC</sub> = 5.0V)

Symbol	Parameter	T <sub>A</sub> = 25°C		Unit
		Typ	Max	
V <sub>OLP</sub>	Quiet Output Maximum Dynamic V <sub>OL</sub>	1.2	1.6	V
V <sub>OLV</sub>	Quiet Output Minimum Dynamic V <sub>OL</sub>	-1.2	-1.6	V
V <sub>IHD</sub>	Minimum High Level Dynamic Input Voltage		2.0	V
V <sub>ILD</sub>	Maximum Low Level Dynamic Input Voltage		0.8	V

## TIMING REQUIREMENTS (Input t<sub>r</sub> = t<sub>f</sub> = 3.0ns)

Symbol	Parameter	Test Conditions	T <sub>A</sub> = 25°C		T <sub>A</sub> = - 40 to 85°C	Unit
			Typ	Limit	Limit	
t <sub>su</sub>	Minimum Setup Time, D to CP	V <sub>CC</sub> = 5.0 ± 0.5 V		6.5	8.5	ns
t <sub>h</sub>	Minimum Hold Time, CP to D	V <sub>CC</sub> = 5.0 ± 0.5 V		2.5	2.5	ns
t <sub>w</sub>	Minimum Pulse Width, CP	V <sub>CC</sub> = 5.0 ± 0.5 V		2.5	2.5	ns

# MC74VHCT574A

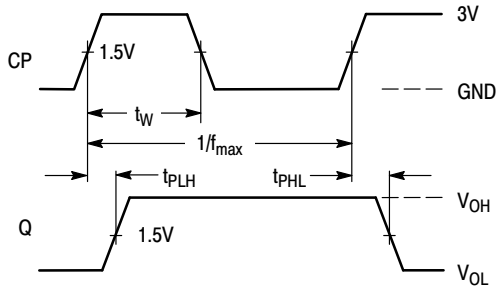


Figure 3. Switching Waveform

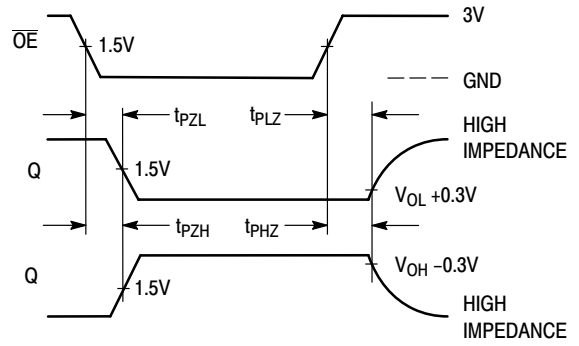


Figure 4. Switching Waveform

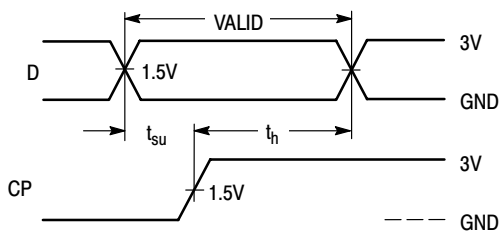
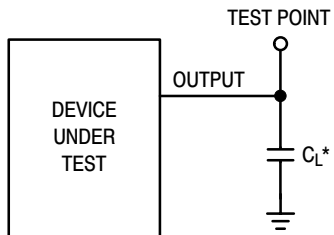
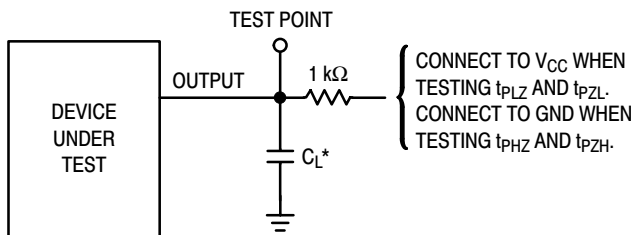


Figure 5. Switching Waveform



\*Includes all probe and jig capacitance

Figure 6. Test Circuit



\*Includes all probe and jig capacitance

Figure 7. Test Circuit

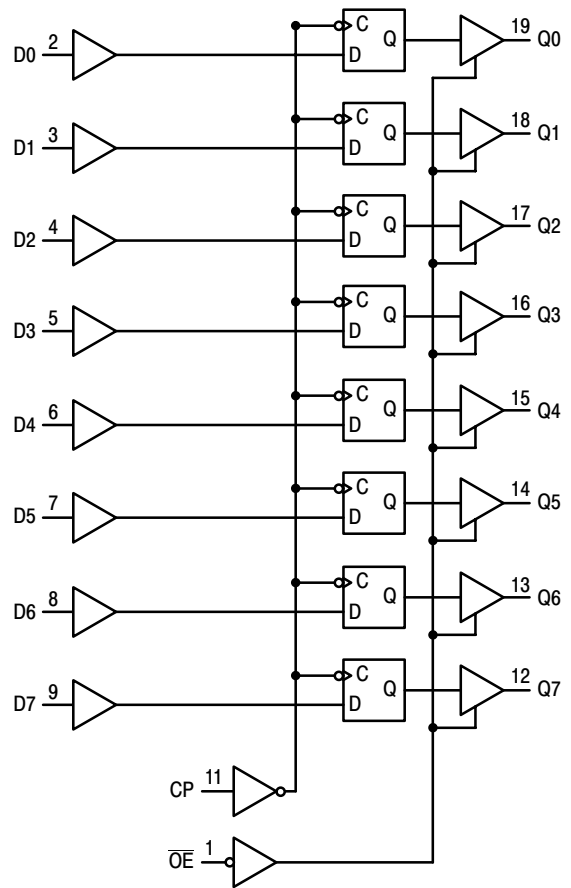
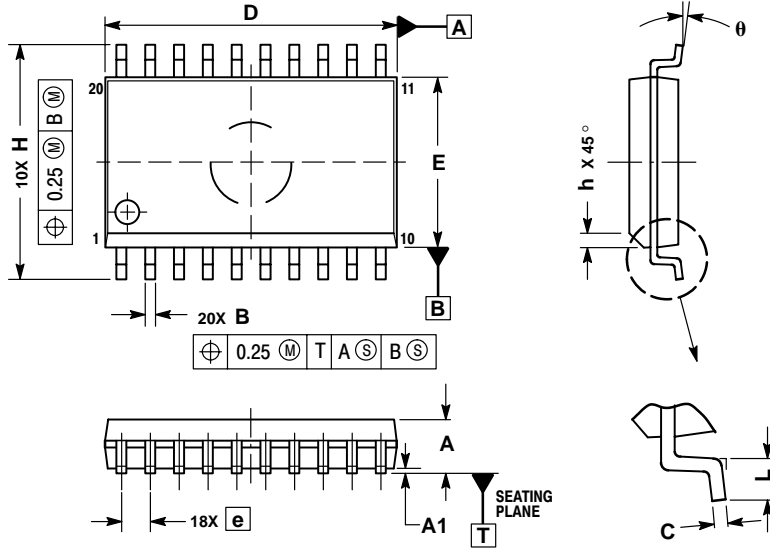


Figure 8. Expanded Logic Diagram

# MC74VHCT574A

## OUTLINE DIMENSIONS

DW SUFFIX  
SOIC  
CASE 751D-05  
ISSUE F



### NOTES:

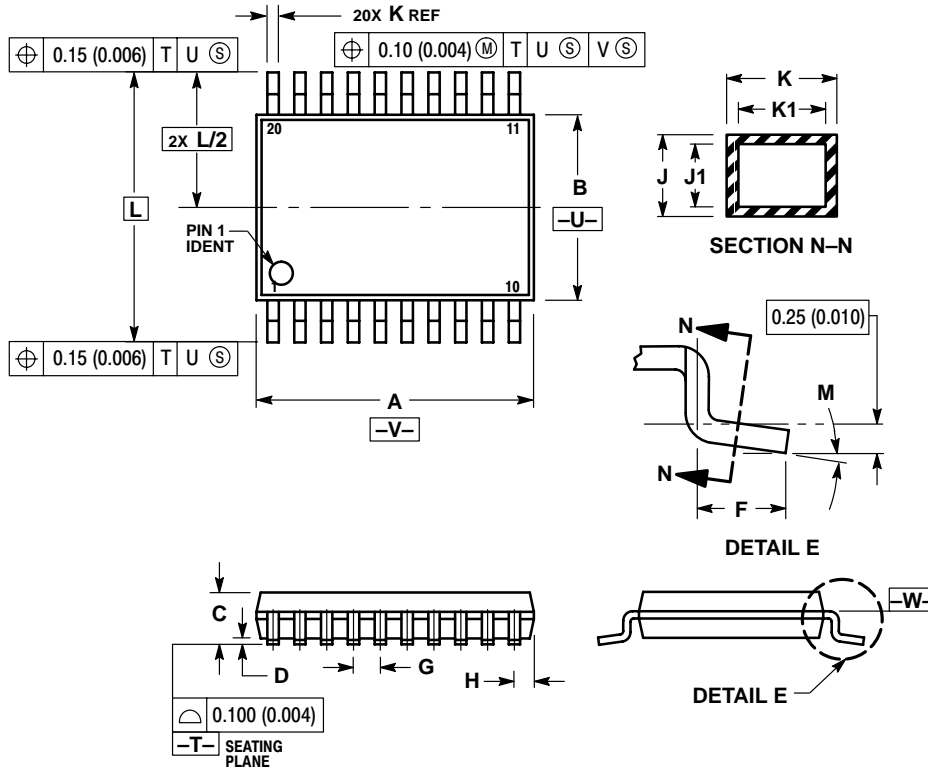
1. DIMENSIONS ARE IN MILLIMETERS.
2. INTERPRET DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994.
3. DIMENSIONS D AND E DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 PER SIDE.
5. DIMENSION B DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE PROTRUSION SHALL BE 0.13 TOTAL IN EXCESS OF B DIMENSION AT MAXIMUM MATERIAL CONDITION.

DIM	MILLIMETERS	
	MIN	MAX
A	2.35	2.65
A1	0.10	0.25
B	0.35	0.49
C	0.23	0.32
D	12.65	12.95
E	7.40	7.60
e	1.27 BSC	
H	10.05	10.55
h	0.25	0.75
L	0.50	0.90
θ	0°	7°

# MC74VHCT574A

## OUTLINE DIMENSIONS

DT SUFFIX  
TSSOP  
CASE 948E-02  
ISSUE A



### NOTES:

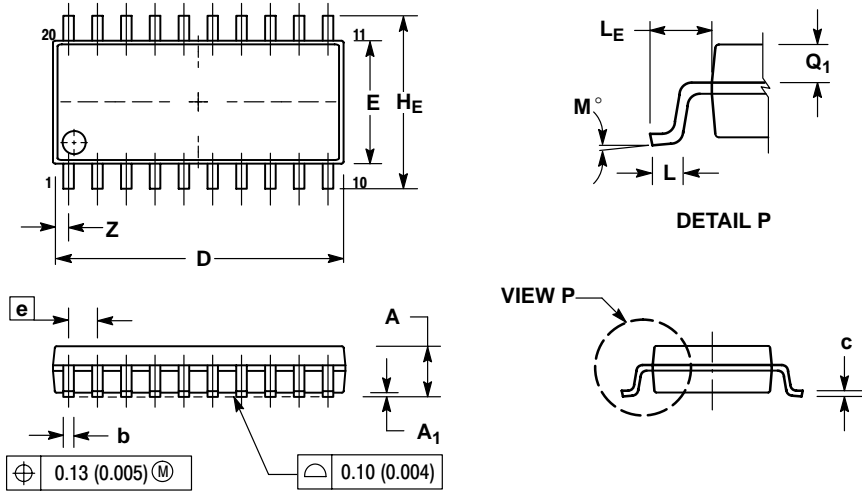
- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- CONTROLLING DIMENSION: MILLIMETER.
- DIMENSION A DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
- DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.
- DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL CONDITION.
- TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
- DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	6.40	6.60	0.252	0.260
B	4.30	4.50	0.169	0.177
C	---	1.20	---	0.047
D	0.05	0.15	0.002	0.006
F	0.50	0.75	0.020	0.030
G	0.65 BSC		0.026 BSC	
H	0.27	0.37	0.011	0.015
J	0.09	0.20	0.004	0.008
J1	0.09	0.16	0.004	0.006
K	0.19	0.30	0.007	0.012
K1	0.19	0.25	0.007	0.010
L	6.40 BSC		0.252 BSC	
M	0°	8°	0°	8°

# MC74VHCT574A

## OUTLINE DIMENSIONS

M SUFFIX  
SOIC EIAJ  
CASE 967-01  
ISSUE O



### NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS AND ARE MEASURED AT THE PARTING LINE. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
4. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
5. THE LEAD WIDTH DIMENSION (b) DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE LEAD WIDTH DIMENSION AT MAXIMUM MATERIAL CONDITION. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE FOOT. MINIMUM SPACE BETWEEN PROTRUSIONS AND ADJACENT LEAD TO BE 0.46 (0.018).

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	---	2.05	---	0.081
A <sub>1</sub>	0.05	0.20	0.002	0.008
b	0.35	0.50	0.014	0.020
c	0.18	0.27	0.007	0.011
D	12.35	12.80	0.486	0.504
E	5.10	5.45	0.201	0.215
e	1.27 BSC		0.050 BSC	
H <sub>E</sub>	7.40	8.20	0.291	0.323
L	0.50	0.85	0.020	0.033
L <sub>E</sub>	1.10	1.50	0.043	0.059
M	0°	10°	0°	10°
Q <sub>1</sub>	0.70	0.90	0.028	0.035
Z	---	0.81	---	0.032

**ON Semiconductor** and  are trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer.

## PUBLICATION ORDERING INFORMATION

### **NORTH AMERICA Literature Fulfillment:**

Literature Distribution Center for ON Semiconductor  
P.O. Box 5163, Denver, Colorado 80217 USA  
**Phone:** 303-675-2175 or 800-344-3860 Toll Free USA/Canada  
**Fax:** 303-675-2176 or 800-344-3867 Toll Free USA/Canada  
**Email:** ONlit@hibbertco.com  
Fax Response Line: 303-675-2167 or 800-344-3810 Toll Free USA/Canada

**N. American Technical Support:** 800-282-9855 Toll Free USA/Canada

**EUROPE:** LDC for ON Semiconductor – European Support

**German Phone:** (+1) 303-308-7140 (Mon-Fri 2:30pm to 7:00pm CET)  
**Email:** ONlit-german@hibbertco.com

**French Phone:** (+1) 303-308-7141 (Mon-Fri 2:00pm to 7:00pm CET)  
**Email:** ONlit-french@hibbertco.com

**English Phone:** (+1) 303-308-7142 (Mon-Fri 12:00pm to 5:00pm GMT)  
**Email:** ONlit@hibbertco.com

**EUROPEAN TOLL-FREE ACCESS\*: 00-800-4422-3781**

\*Available from Germany, France, Italy, UK, Ireland

### **CENTRAL/SOUTH AMERICA:**

**Spanish Phone:** 303-308-7143 (Mon-Fri 8:00am to 5:00pm MST)  
**Email:** ONlit-spanish@hibbertco.com

**Toll-Free from Mexico:** Dial 01-800-288-2872 for Access –  
then Dial 866-297-9322

**ASIA/PACIFIC:** LDC for ON Semiconductor – Asia Support

**Phone:** 1-303-675-2121 (Tue-Fri 9:00am to 1:00pm, Hong Kong Time)  
**Toll Free from Hong Kong & Singapore:**

**001-800-4422-3781**

**Email:** ONlit-asia@hibbertco.com

**JAPAN:** ON Semiconductor, Japan Customer Focus Center

4-32-1 Nishi-Gotanda, Shinagawa-ku, Tokyo, Japan 141-0031

**Phone:** 81-3-5740-2700

**Email:** r14525@onsemi.com

**ON Semiconductor Website:** <http://onsemi.com>

For additional information, please contact your local  
Sales Representative.



[News Room](#)[Sales & Distribution](#)[About Us](#)[Investor Relations](#)[Employment](#)[Technical Documents](#)[Products](#)[Broadband Solution ICs](#)[Power Management](#)[Product Catalog](#)[New Products](#)[Competitor Cross Reference](#)[Applications Catalog](#)[Technical Documents](#)[CD/Document Ordering](#)[Models](#)[Reliability Data](#)[PCNs](#)[Samples FAQ](#)[Part Nomenclature](#)[Purchasing T's and C's](#)[Tech Support](#)[ON-Line Services](#)[Print Page](#)

## Device MC74VHCT574A

### Octal D-Type Flip-Flop with 3-State Output

[Data Sheet](#) MC74VHCT574A/D - 96.0 (kb)

The MC74VHCT574A is an advanced high speed CMOS octal flip-flop with 3-state output fabricated with silicon gate CMOS technology. It achieves high speed operation similar to equivalent Bipolar Schottky TTL while maintaining CMOS low power dissipation.

This 8-bit D-type flip-flop is controlled by a clock input and an output enable input. When the output enable input is high, the eight outputs are in a high impedance state.

The VHCT inputs are compatible with TTL levels. This device can be used as a level converter for interfacing 3.3V to 5.0V, because it has full 5V CMOS level output swings.

The VHCT574A input and output (when disabled) structures provide protection when voltages between 0V and 5.5V are applied, regardless of the supply voltage. These input and output structures help prevent device destruction caused by supply voltage - input/output voltage mismatch, battery backup, hot insertion, etc.

**Features:**

- High Speed:  $f_{max} = 140\text{MHz}$  (Typ) at  $V_{CC} = 5\text{V}$
- Low Power Dissipation:  $I_{CC} = 4\mu\text{A}$  (Max) at  $T_A = 25\text{C}$
- TTL-Compatible Inputs:  $V_{IL} = 0.8\text{V}$ ;  $V_{IH} = 2.0\text{V}$
- Power Down Protection Provided on Inputs and Outputs
- Balanced Propagation Delays
- Designed for 4.5V to 5.5V Operating Range
- Low Noise:  $V_{OLP} = 1.6\text{V}$  (Max)
- Pin and Function Compatible with Other Standard Logic Families
- Latchup Performance Exceeds 300mA
- ESD Performance: HBM > 2000V; Machine Model > 200V
- Chip Complexity: 286 FETs or 71.5 Equivalent Gates

**Orderable Devices**

Action	Device	Status	Package			Container		Budgetary Price/Unit
			Type	Pins	Case Outline	Type	Qty.	
<a href="#">Order Samples</a>	MC74VHCT574ADT	Active	TSSOP	20	<a href="#">948E-02</a>	Rail	75	\$0.267
<a href="#">Order Samples</a> <a href="#">Buy Now</a>	MC74VHCT574ADTR2	Active	TSSOP	20	<a href="#">948E-02</a>	Tape and Reel	2,500	\$0.267
<a href="#">Order Samples</a> <a href="#">Buy Now</a>	MC74VHCT574ADW	Active	SOIC	20	<a href="#">751D-05</a>	Rail	38	\$0.267
<a href="#">Order Samples</a>	MC74VHCT574ADWR2	Active	SOIC	20	<a href="#">751D-05</a>	Tape and Reel	1,000	\$0.267
<a href="#">Order Samples</a>	MC74VHCT574AM	Active	SOEIAJ-20	20	<a href="#">967-01</a>	Rail	40	\$0.267
<a href="#">Order Samples</a> <a href="#">Buy Now</a>	MC74VHCT574AMEL	Active	SOEIAJ-20	20	<a href="#">967-01</a>	Tape and Reel	2,000	\$0.267
N/A	MC74VHCT574AML1	Last Shipments	SOEIAJ-20	20	<a href="#">967-01</a>	Tape and Reel		
N/A	MC74VHCT574AML2	Last Shipments	SOEIAJ-20	20	<a href="#">967-01</a>	Tape and Reel		

[Login](#) | [Register](#) | [Site Index](#) | [Contact Us](#) | [Home](#) | [China Site](#)

[Products](#) | [News Room](#) | [Sales](#) | [About](#) | [Investor](#) | [Employment](#)

[Privacy Policy](#), [© Copyright 1999-2001. All rights reserved.](#) [Terms of Use](#).